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To the Director of the U.S. Patent and Trademark Office: Please	17 record the attached documents or the new address(es) below.				
Name of conveying party(ies):	2. Name and address of receiving party(ies)				
Michio Deguchi (8/31/2006) and Ayako Morita (8/27/2006)	Name: Sony Corporation				
	Internal Address:				
Additional name(s) of conveying party(ies) attached? Yes X No	Street Address:				
3. Nature of conveyance/Execution Date(s):					
Execution Date(s): in parentheses after inventor name	6-7-35 Kitashinagawa Shinagawa-Ku,				
X Assignment Merger Change of Name	Similagana na,				
Security Agreement Joint Research Agreement	City: Tokyo				
Government Interest Assignment	State:				
Executive Order 9424, Confirmatory License	Country: JAPAN Zip: 141-0001				
Other	Additional name(s) & address(es) Yes X No attached?				
A. Patent Application No.(s) 29/262,955 Additional numbers attached?	B. Patent No.(s)				
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:				
Name: RADER, FISHMAN & GRAUER PLLC	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00				
Internal Address: Atty. Dkt.: SDE-2015	Authorized to be charged by credit card				
Street Address: 1233 20th Street, N.W.	X Authorized to be charged to deposit account				
Suite 501	Enclosed				
	None required (government interest not affecting title)				
City: Washington	8. Payment Information				
State: DC Zip: 20036	a. Credit Card Last 4 Numbers				
Phone Number: (202) 955-3750	Expiration Date				
Fax Number: (202) 955-3751	b. Deposit Account Number 18-0013 Authorized User Name Toshikatsu Imaizumi				
Email Address:	Audionzed Oser Marile TOSHIKAtSU IMIAIZUMI				
9. Signature:					
Signature Date Tookily Tou Impiriting L 0046 Total number of pages including cover					
Toshikatsu Imaizumi - L0046	Total number of pages including cover sheet, attachments, and documents: 3				

09/18/2006 MJAM91 00000023 180013 29262955 01 FC:8021 40.00 DA

REEL: 018312 FRAME: 0302

Docket Number: SDE-2015

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

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for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, **SONY CORPORATION**, a Japanese corporation with effices at 6-7-35 Kitashinagawa, Shinagawa-ku, Tokyo, JAPAN, (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of Ten Dollar (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

PATENT REEL: 018312 FRAME: 0303 And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number:

, Filing Date:

This assignment executed on the dates indicated below.

Michio DEGUCHI	mkhio Ll	Peguchi	August 31, 2006
		Signature	Date
Ayako MORITA	augafaer me	rita	August 27. 2006
		Signature	Date
		Signature	Date
		Signature	Date

PATENT REEL: 018312 FRAME: 0304

RECORDED: 09/14/2006